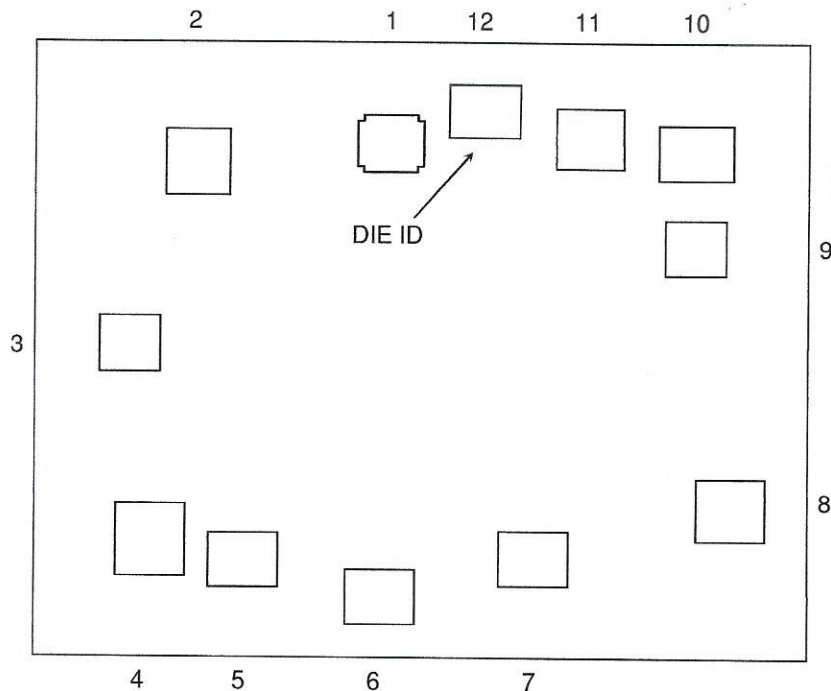




Sierra Components, Inc.

2222 Park Place, 3-E • Minden, Nevada 89423

Phone: 775.783.4940 Fax: 775.783.4947



PAD	FUNCTION
1	1A
2	1B
3	1Y
4	STROBE 1G
5	STROBE S
6	GND
7	STROBE 2G
8	2Y
9	2B
10	2A
11	V _{CC-}
12	V _{CC+}

NOTE:

- This data is supplied for general information only and is believed to be correct at the time of publication.
- For critical applications, the customer is advised to verify device revision and pad coordinates, prior to processing
- Changes can be made without notification from the manufacturer. Die devices cannot accept liability in that event

Topside Metal: (AL)
Backside Metal: (Si)
Backside Potential: GND
Bond Pad Size: .004" x .004" min
Mask Ref:

APPROVED BY: MG

DIE SIZE: 48 x 44 Mils

DATE: 7/17/17

MFG: Texas Instruments

THICKNESS:

P/N: SN75107B